

1. Description

The BLM075N04 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

KEY CHARACTERISTICS

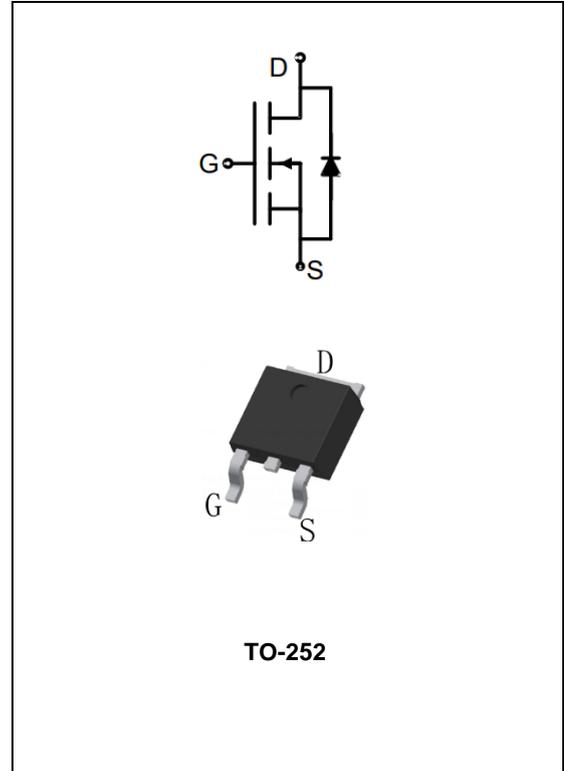
Parameter	Value	Unit
V_{DS}	40	V
I_D	60	A
$R_{DS(ON)}@10V_{Typ}$	5.4	m Ω
$R_{DS(ON)}@4.5V_{Typ}$	7.8	m Ω

FEATURES

- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- LeadFree

APPLICATIONS

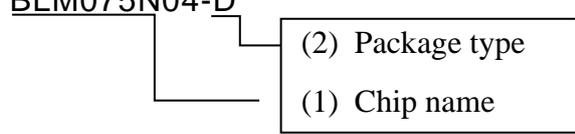
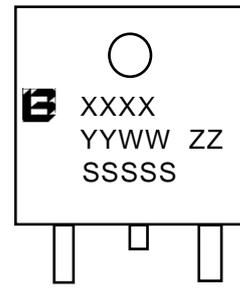
- LoadSwitch
- PWMApplication
- PowerManagement



100% UIS TESTED!
100% ΔV_{ds} TESTED!

ORDERING INFORMATION

Device Marking	Ordering Codes	Package	Product Code	Packing
M075N04	BLM075N04-D	TO-252	BLM075N04	Reel

<p>BLM075N04-D</p>  <p>(1) BLM075N04:40V 7.5mΩ</p>	 <p>XXXX: Product Code YYWW: Year&Week ZZ: Assembly Code SSSSS: Lot Code</p>
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2. ABSOLUTE RATINGS

at $T_c = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	40	V
I_D	Continuous Drain Current	60	A
$I_{DM}(\text{Note1})$	Pulsed Drain Current	240	A
P_D	Power Dissipation	44.6	W
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulse Avalanche Energy(Note2)	51	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

3. Thermal characteristics

Symbol	Parameter	RATINGS	Units
$R_{\theta JC}$	Junction-to- Case	2.8	$^\circ\text{C}/\text{W}$

4. Electrical Characteristics

at $T_c = 25^\circ\text{C}$, unless otherwise specified

OFF Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	40	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=40\text{V}, V_{GS}=0\text{V}$	--	--	1	μA
I_{GSS}	Gate to Source Forward Leakage	$V_{GS}=\pm 20\text{V}$	--	--	100	nA

ON Characteristics

Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$ (Note3)	Drain-to-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A},$	--	5.4	7.5	m Ω
		$V_{GS}=4.5\text{V}, I_D=10\text{A},$	--	7.8	12	
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}(\text{Note2})$	1	1.9	2.4	V

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
C _{iss}	Input Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1.0MHz	--	2363	--	pF
C _{oss}	Output Capacitance		--	150	--	
C _{rss}	Reverse Transfer Capacitance		--	124	--	

Switching Characteristics						
Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	V _{DD} = 20V I _D = 2A R _L = 1Ω R _{GEN} = 3Ω V _{GS} = 10V	--	6.4	--	ns
t _r	Rise Time		--	17.2	--	
t _{d(OFF)}	Turn-Off Delay Time		--	29.6	--	
t _f	Fall Time		--	16.8	--	
Q _g	Total Gate Charge	I _D = 20A V _{DD} = 10V V _{GS} = 10V	--	45	--	nC
Q _{gd}	Gate to Drain ("Miller") Charge		--	5.8	--	
Q _{gs}	Gate to Source Charge		--	9	--	

Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Values			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current (Body Diode)	TC=25 °C	--	--	60	A
V _{SD}	Diode Forward Voltage	I _S =20A, V _{GS} =0V(Note2)	--	--	1.2	V

Note1: Pulse width limited by maximum junction temperature
 Note2: Eas condition: T_j=25°C, V_G=10V, L=0.5mH, I_{as}=15A
 Note3: Pulse width t_p ≤ 300μs, δ ≤ 2%

5. Characteristics Curves

Figure 1 Output Characteristics

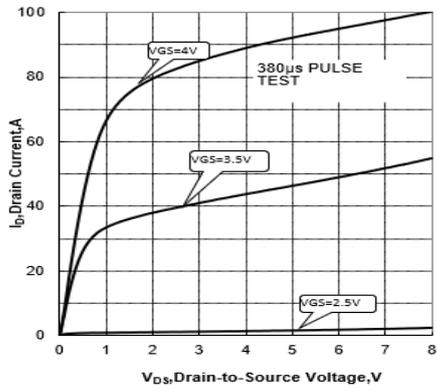


Figure 2 Transfer Characteristics

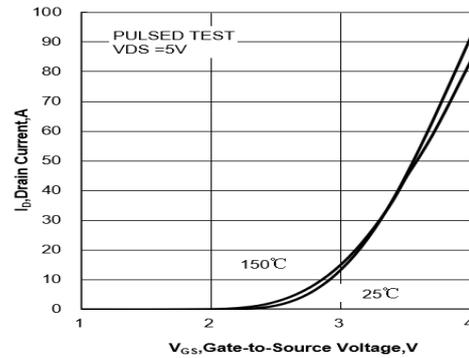


Figure 3 On-Resistance vs. I_D

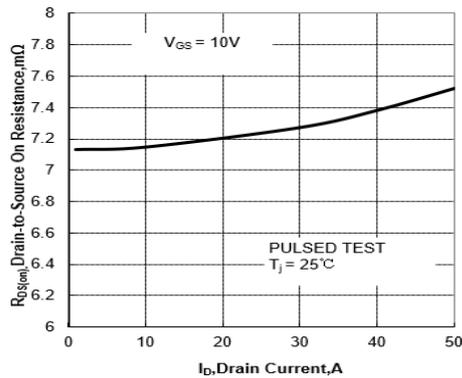


Figure 4 On-Resistance vs. Junction Temperature

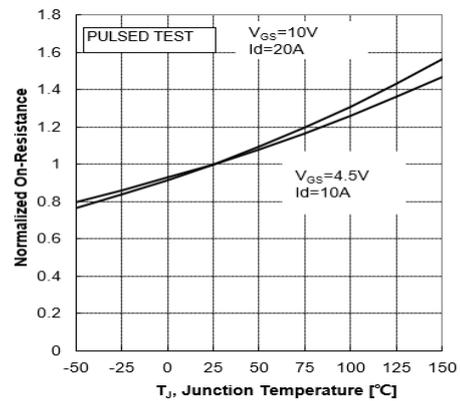


Figure 5 BV vs Junction Temperature

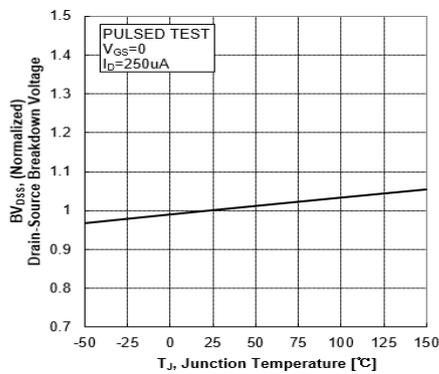


Figure 6 Vth vs Junction Temperature

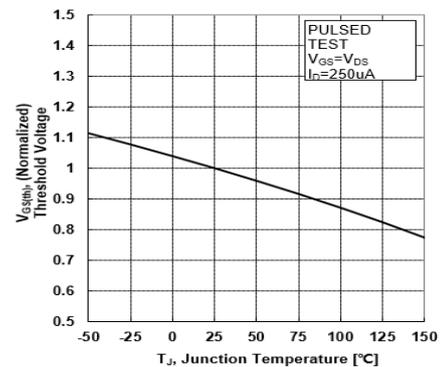


Figure 7 Gate-Charge Characteristics

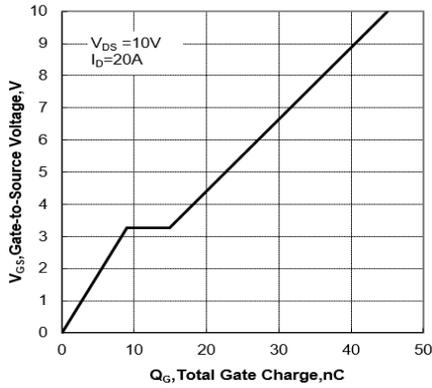


Figure 8 Capacitance Characteristics

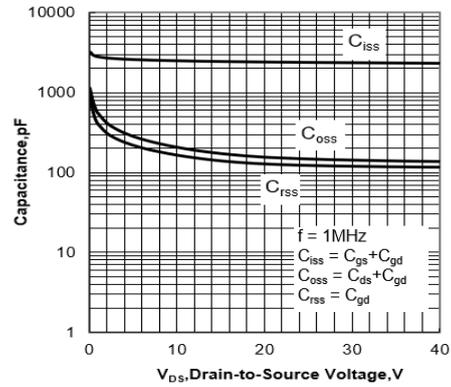


Figure 9 Body Diode Forward Voltage

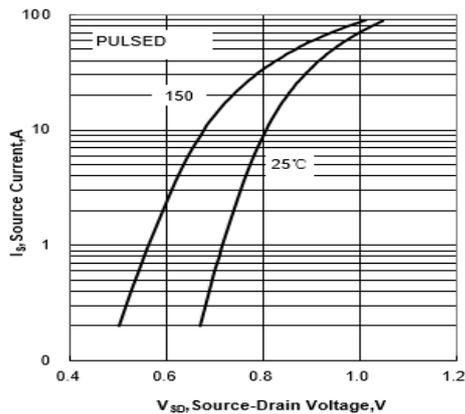


Figure 10 Maximum Safe Operating Area

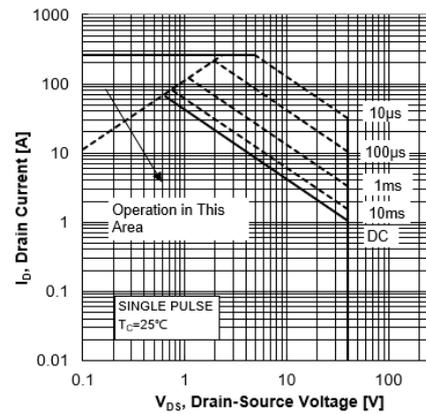
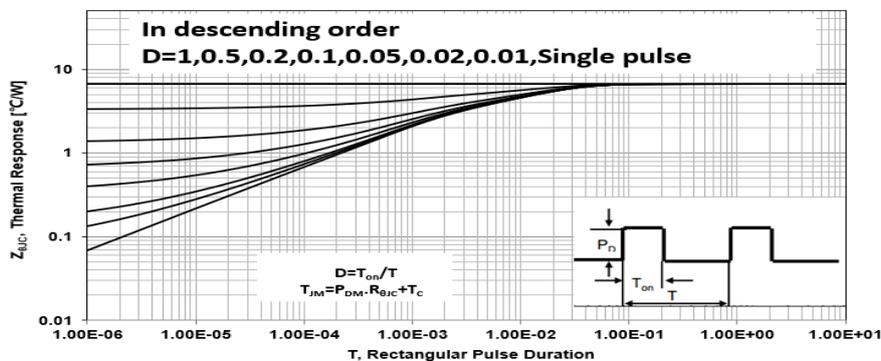
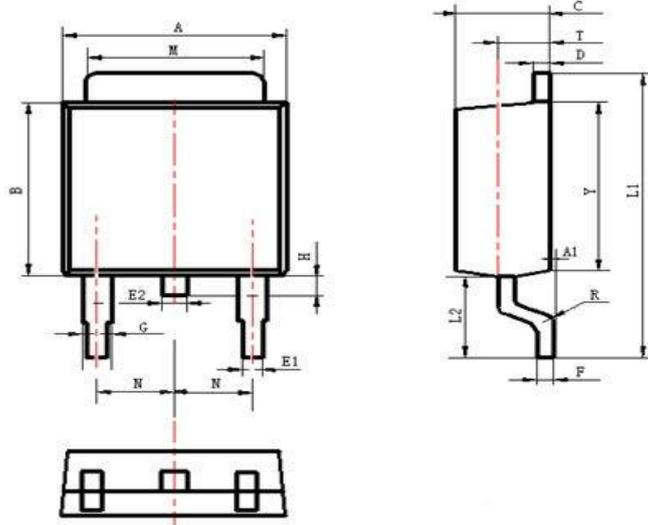


Figure 11 Transient Thermal Impedance



Package Description



Items	Values(mm)	
	MIN	MAX
A	6.30	6.90
A1	0	0.13
B	5.70	6.30
C	2.10	2.50
D	0.30	0.60
E1	0.60	0.90
E2	0.70	1.00
F	0.30	0.60
G	0.70	1.20
L1	9.60	10.50
L2	2.70	3.10
H	0.60	1.00
M	5.10	5.50
N	2.09	2.49
R	0.3	
T	1.40	1.60
Y	5.10	6.30

TO-252 Package

NOTE:

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. Shanghai Belling reserves the right to make changes in this specification sheet and is subject to change without prior notice.

CONTACT:

上海贝岭股份有限公司 (总部)

地址: 上海市宜山路 810 号

邮编: 200233

电话: 021-24261000

产品业务咨询及技术支持

电话: 021-24261326

传真 2: 021-64852222

邮箱 2: marketing@belling.com.cn

上海贝岭深圳分公司 (华南区)

地址: 深圳市福田区中心区民田路新华保险大厦 1510 室

邮编: 518031

电话: 0755-33336776 0755-33336770

传真: 0755-33336788

上海贝岭北京办事处 (华北区)

地址: 北京市西城区新华里 16 号院锦官苑小区 10 号楼 1 单元 1505 室

邮编: 100044

电话: 010-64179374

传真: 010-8835 9236